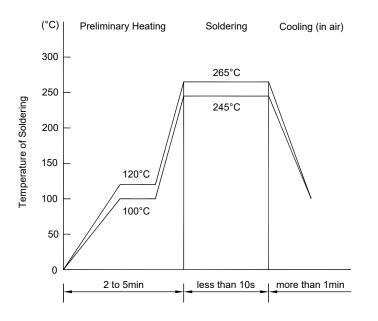
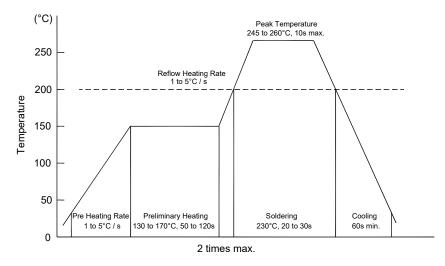
Recommended condition of flow soldering



• Recommended condition of reflow soldering



Recommended peak temperature is over 245 °C. If peak temperature is below 245 °C, you may adjust the following parameters; time length of peak temperature (longer), time length of soldering (longer), thickness of solder paste (thicker)

Condition of hand soldering

Temperature: 370 °C Time: 3 s max. Times: one time

• Remark: Lead free solder paste (96.5Sn/3.0Ag/0.5Cu)



Dated: 26/04/2022 Rev: 08